

# LUW CEUP.CE

## OSLON® Compact CL

Compact light source with a typical luminous flux of 200 lm at 700 mA and an operation range of 50 mA up to 1500 mA.



### Applications

- Headlamps, LED & Laser & Night Vision

### Features:

- Package: Ceramic package
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.33, Cy = 0.34 acc. to CIE 1931 (● ultra white)
- Corrosion Robustness Class: 3A
- Qualifications: AEC-Q102 Qualified
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

## Ordering Information

Type	Luminous Flux <sup>1)</sup> I <sub>F</sub> = 700 mA Φ <sub>v</sub>	Ordering Code
LUW CEUP.CE-5M6N-HNJN-8E8G	180 ... 355 lm	Q65112A3912

## Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	$T_{op}$	min.	-40 °C
		max.	125 °C
Storage Temperature	$T_{stg}$	min.	-40 °C
		max.	125 °C
Junction Temperature	$T_j$	max.	150 °C
Junction Temperature for short time applications*	$T_j$	max.	175 °C
Forward Current $T_s = 25\text{ °C}$	$I_F$	min.	50 mA
		max.	1500 mA
Surge Current $t \leq 10\ \mu\text{s}$ ; $D = 0.005$ ; $T_s = 25\text{ °C}$	$I_{FS}$	max.	2500 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	$V_{ESD}$		8 kV
Reverse current <sup>2)</sup>	$I_R$	max.	200 mA

\* The median lifetime (L70/B50) for  $T_j = 175\text{ °C}$  is 100h.

## Characteristics

$I_F = 700 \text{ mA}$ ;  $T_s = 25 \text{ °C}$

Parameter	Symbol		Values
Chromaticity Coordinate <sup>3)</sup>	$C_x$	typ.	0.33
	$C_y$	typ.	0.34
Viewing angle at 50% $I_V$	$2\phi$	typ.	120 °
Forward Voltage <sup>4)</sup> $I_F = 700 \text{ mA}$	$V_F$	min.	2.75 V
		typ.	3.13 V
		max.	3.50 V
Reverse voltage (ESD device)	$V_{R\text{ ESD}}$	min.	45 V
Reverse voltage <sup>2)</sup> $I_R = 20 \text{ mA}$	$V_R$	max.	1.2 V
Real thermal resistance junction/solderpoint <sup>5)</sup>	$R_{\text{thJS real}}$	typ.	5.7 K / W
		max.	7.3 K / W
Electrical thermal resistance junction/solderpoint <sup>5)</sup> with efficiency $\eta_e = 28 \text{ %}$	$R_{\text{thJS elec.}}$	typ.	4.1 K / W
		max.	5.3 K / W

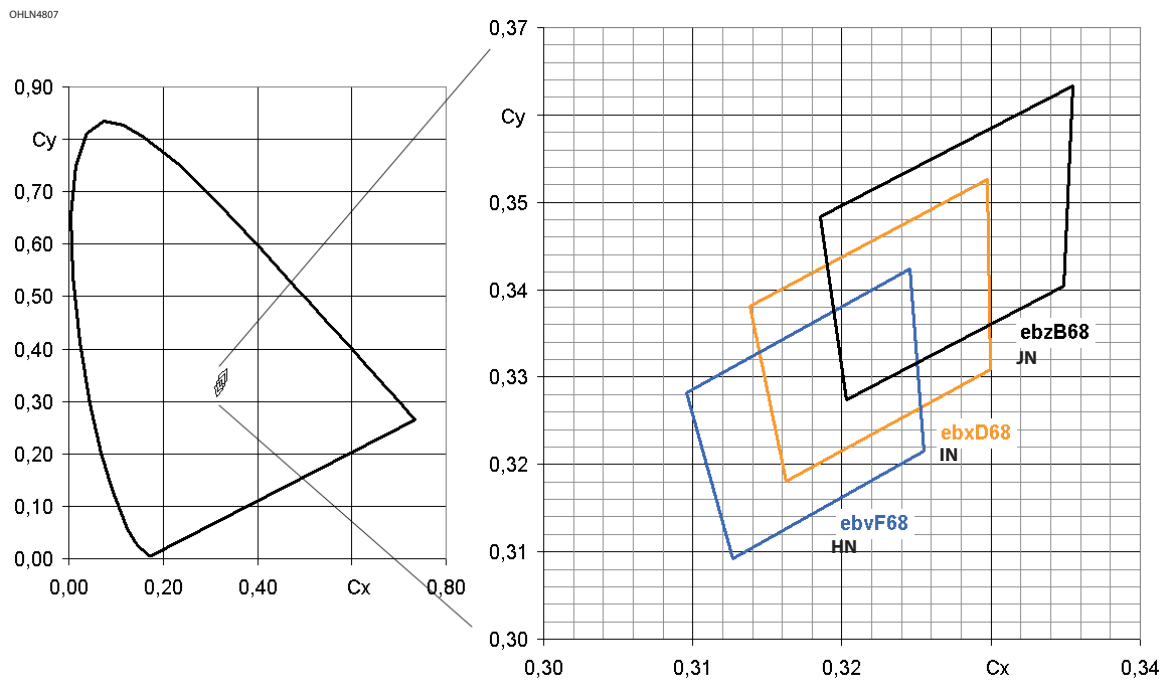
## Brightness Groups

Group	Luminous Flux <sup>1)</sup> $I_F = 700 \text{ mA}$ min. $\Phi_V$	Luminous Flux <sup>1)</sup> $I_F = 700 \text{ mA}$ max. $\Phi_V$	Luminous Intensity <sup>6)</sup> $I_F = 700 \text{ mA}$ typ. $I_v$
5M	180 lm	201 lm	63 cd
6M	201 lm	224 lm	70 cd
M7	210 lm	224 lm	72 cd
7M	224 lm	250 lm	78 cd
8M	250 lm	280 lm	88 cd
5N	280 lm	315 lm	98 cd
6N	315 lm	355 lm	111 cd

## Forward Voltage Groups

Group	Forward Voltage <sup>4)</sup> $I_F = 700 \text{ mA}$ min. $V_F$	Forward Voltage <sup>4)</sup> $I_F = 700 \text{ mA}$ max. $V_F$
8E	2.75 V	3.00 V
8F	3.00 V	3.25 V
8G	3.25 V	3.50 V

### Chromaticity Coordinate Groups <sup>3)</sup>



### Chromaticity Coordinate Groups <sup>3)</sup>

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
HN	0.3127	0.3093	IN	0.3163	0.3181	JN	0.3203	0.3274
	0.3255	0.3216		0.3300	0.3308		0.3349	0.3404
	0.3246	0.3424		0.3298	0.3526		0.3355	0.3633
	0.3096	0.3282		0.3138	0.3381		0.3186	0.3484

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## Group Name on Label

**Example: 5M-HN-8E**

Brightness

Color Chromaticity

Forward Voltage

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5M

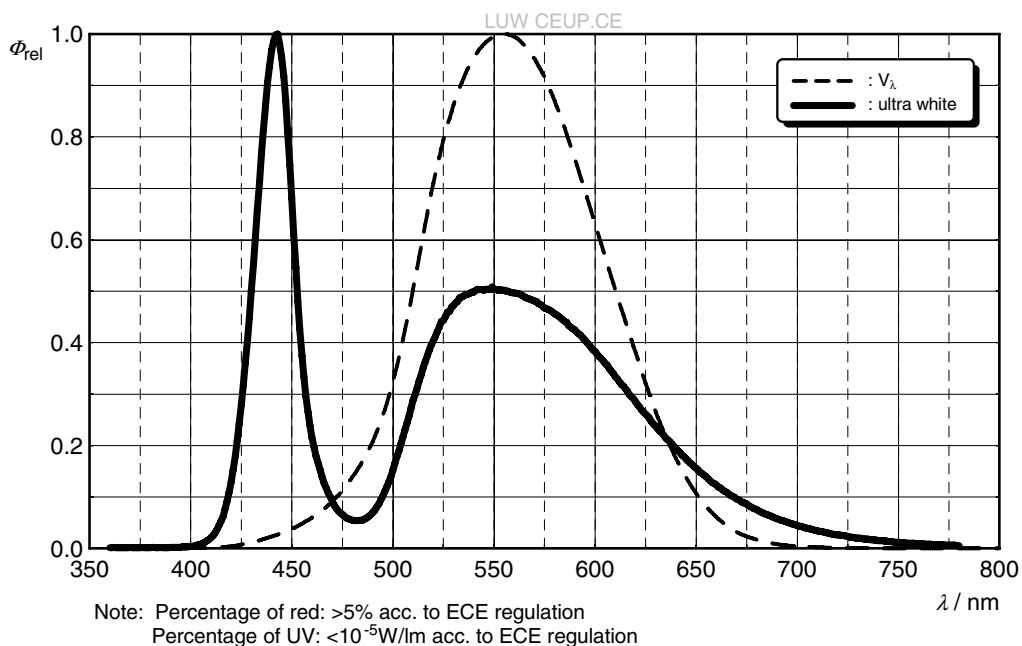
HN

8E

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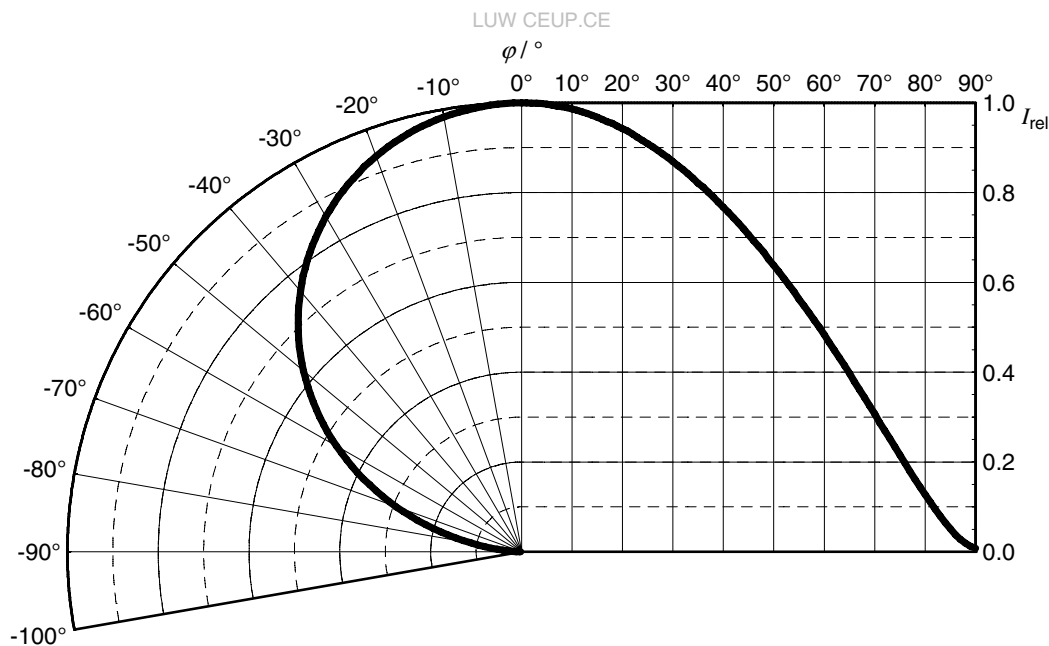
### Relative Spectral Emission <sup>6)</sup>

$\Phi_{rel} = f(\lambda); I_F = 700 \text{ mA}; T_S = 25 \text{ }^\circ\text{C}$



### Radiation Characteristics <sup>6)</sup>

$I_{rel} = f(\phi); T_S = 25 \text{ }^\circ\text{C}$

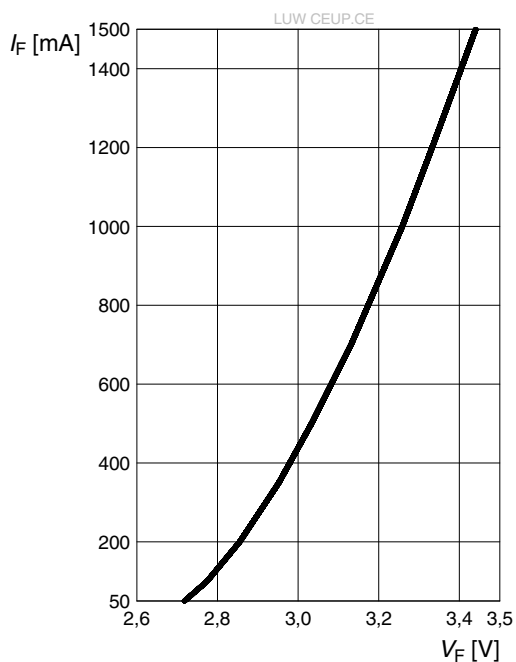


Not for new design



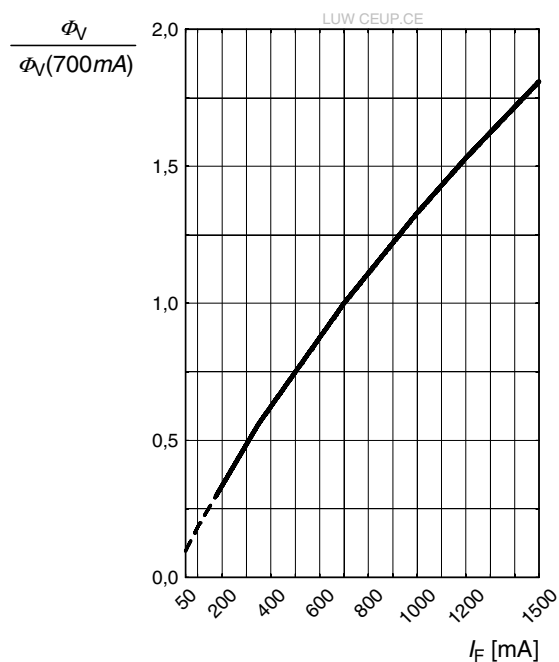
### Forward current <sup>6), 7)</sup>

$$I_F = f(V_F); T_S = 25\text{ °C}$$



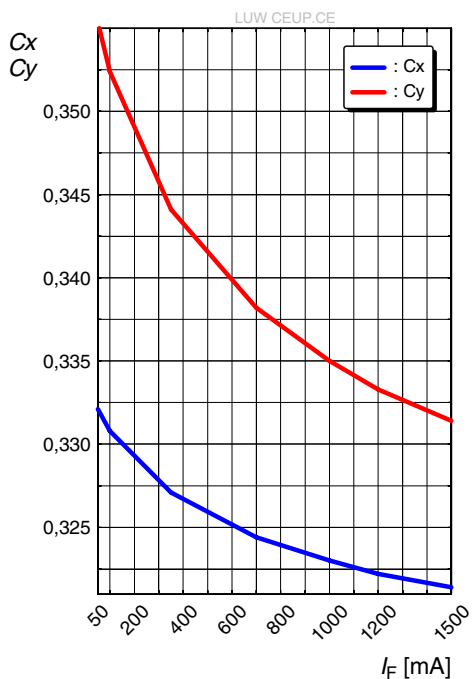
### Relative Luminous Flux <sup>6), 7)</sup>

$$\Phi_V / \Phi_V(700\text{ mA}) = f(I_F); T_S = 25\text{ °C}$$



### Chromaticity Coordinate Shift <sup>6)</sup>

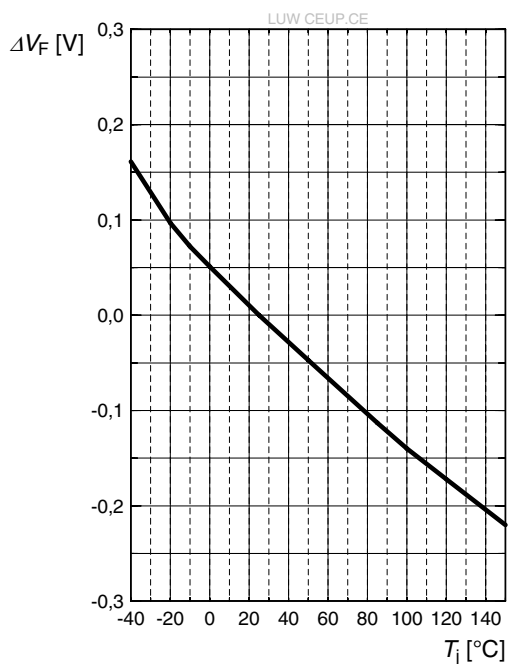
$$C_x, C_y = f(I_F); T_S = 25\text{ °C}$$



Not for new design

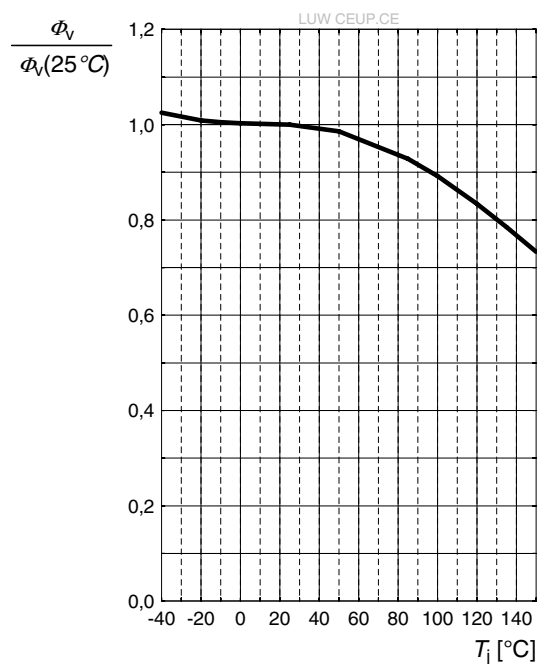
### Forward Voltage <sup>6)</sup>

$$\Delta V_F = V_F - V_F(25\text{ }^\circ\text{C}) = f(T_j); I_F = 700\text{ mA}$$



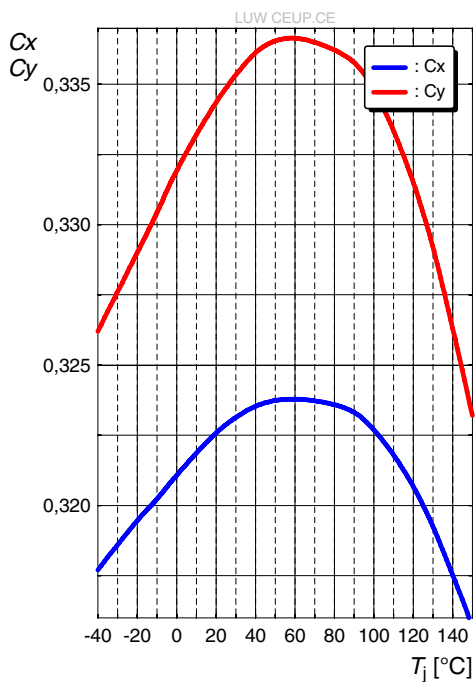
### Relative Luminous Flux <sup>6)</sup>

$$\Phi_V / \Phi_V(25\text{ }^\circ\text{C}) = f(T_j); I_F = 700\text{ mA}$$



### Chromaticity Coordinate Shift <sup>6)</sup>

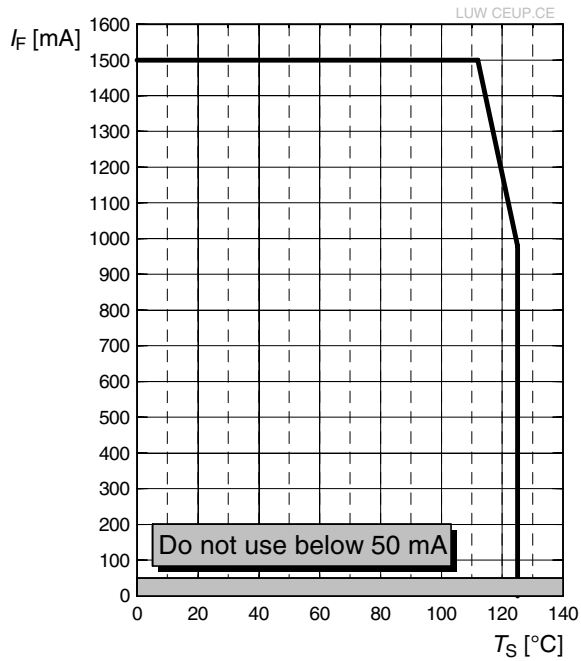
$$C_x, C_y = f(T_j); I_F = 700\text{ mA}$$



Not for new design

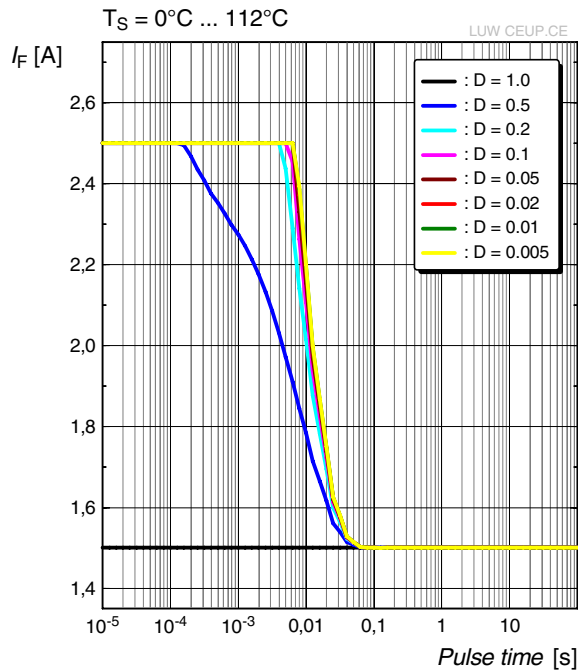
### Max. Permissible Forward Current

$I_F = f(T)$



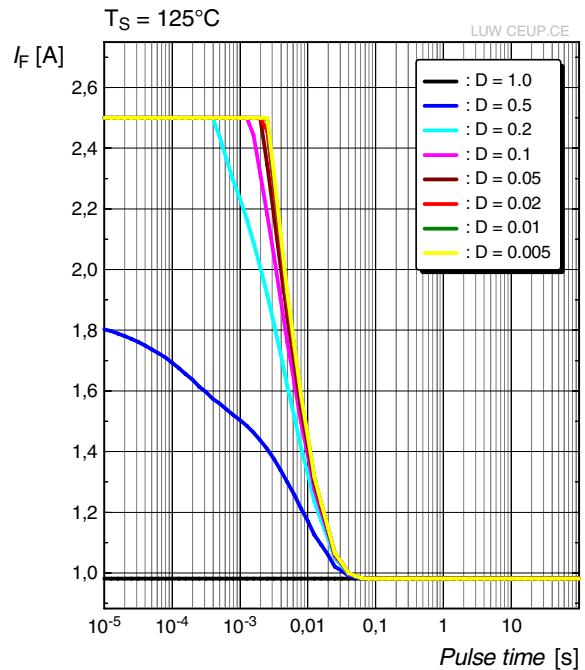
### Permissible Pulse Handling Capability

$I_F = f(t_p)$ ; D: Duty cycle,  $T_S = 25^\circ\text{C}$



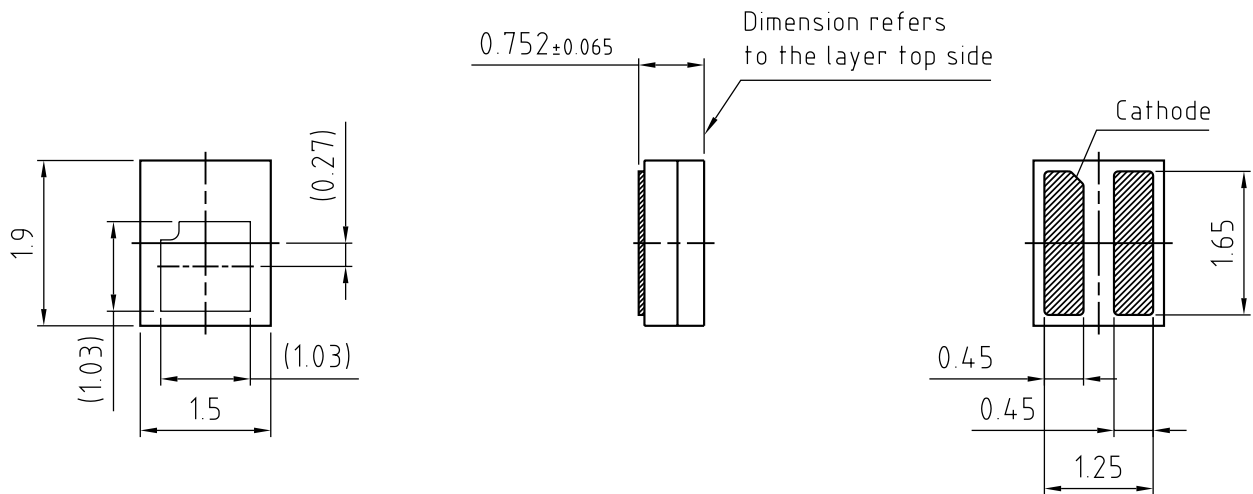
### Permissible Pulse Handling Capability


$I_F = f(t_p)$ ; D: Duty cycle,  $T_S = 125^\circ\text{C}$



Not for new design

## Dimensional Drawing <sup>8)</sup>



general tolerance  $\pm 0.05$   
 lead finish Au 

C63062-A4138-A3-05

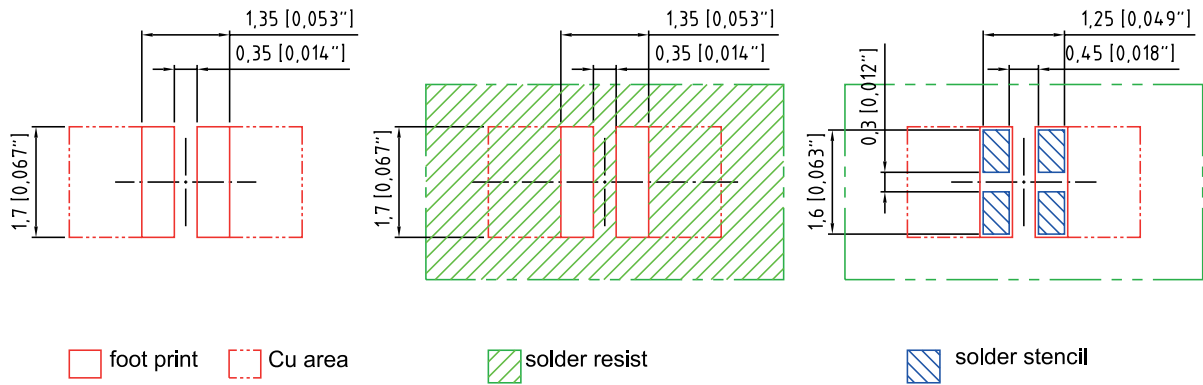
## Further Information:

**Approximate Weight:** 7.8 mg

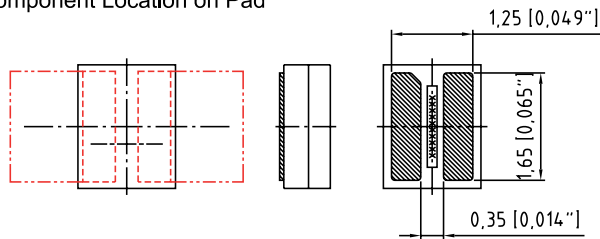
**Corrosion test:** Class: 3A  
 Test condition: 40°C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter than IEC 60068-2-43)

**ESD advice:** The device is protected by ESD device which is connected in parallel to the Chip.

## Recommended Solder Pad <sup>8)</sup>



Component Location on Pad

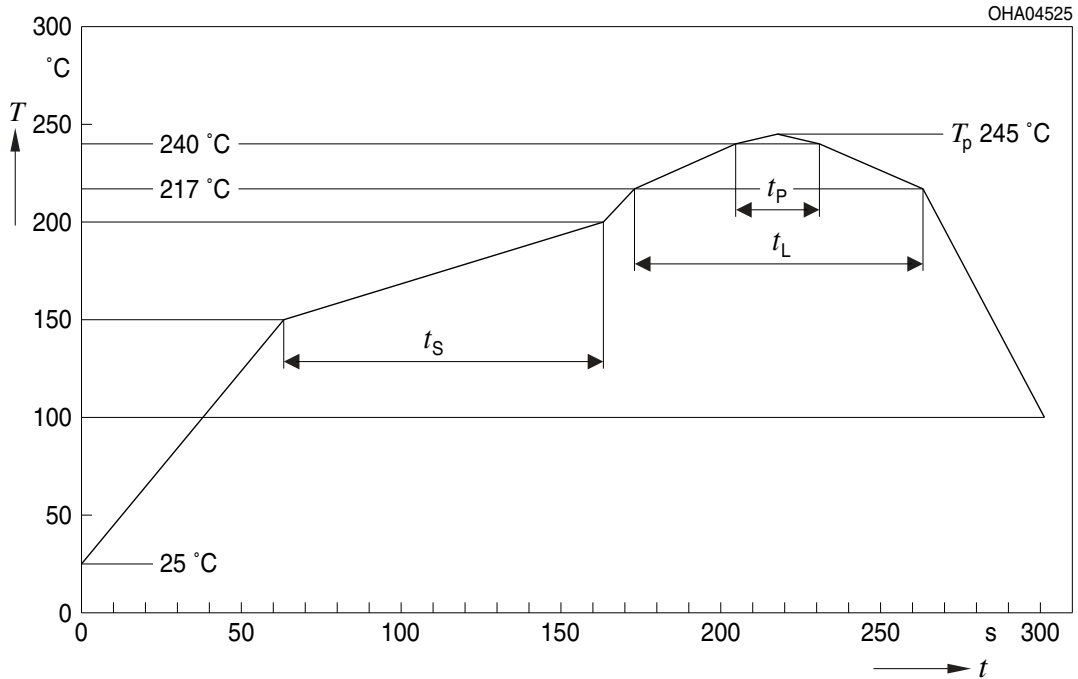


E062.3010.105-02

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

## Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

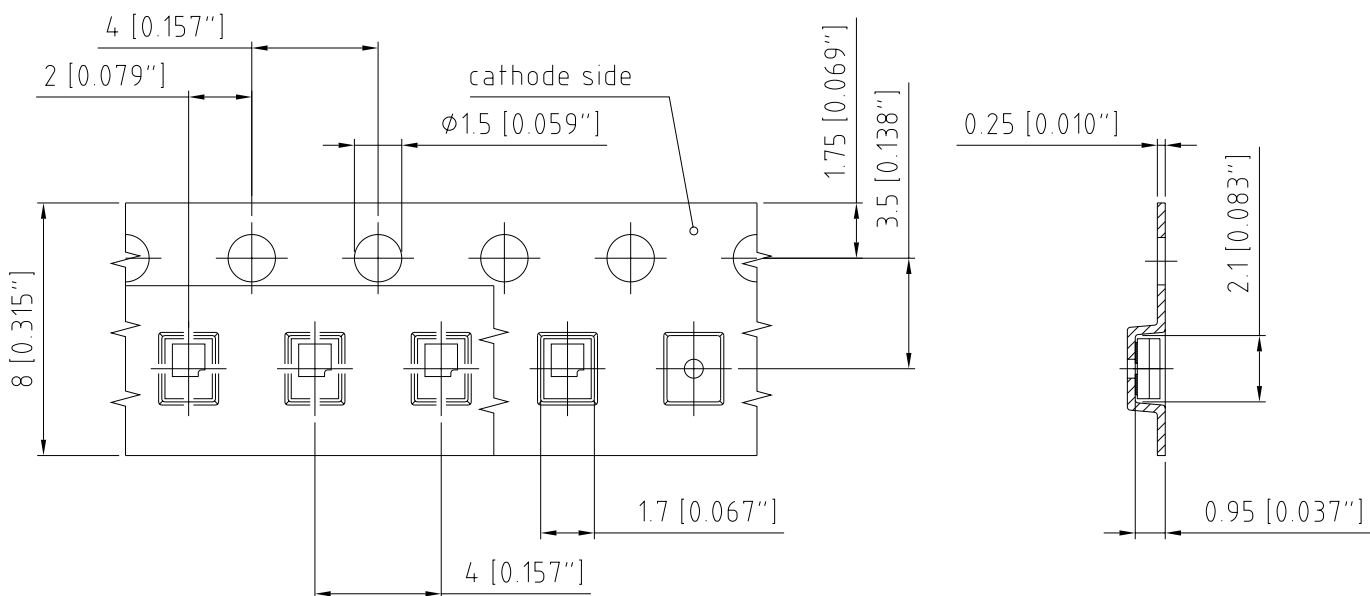


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat <sup>*)</sup> 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak <sup>*)</sup> $T_{Smax}$ to $T_p$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_p$		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	$t_p$	10	20	30	s
Ramp-down rate* $T_p$ to 100 °C			3	6	K/s
Time 25 °C to $T_p$				480	s

All temperatures refer to the center of the package, measured on the top of the component  
 \*) slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

Not for new design

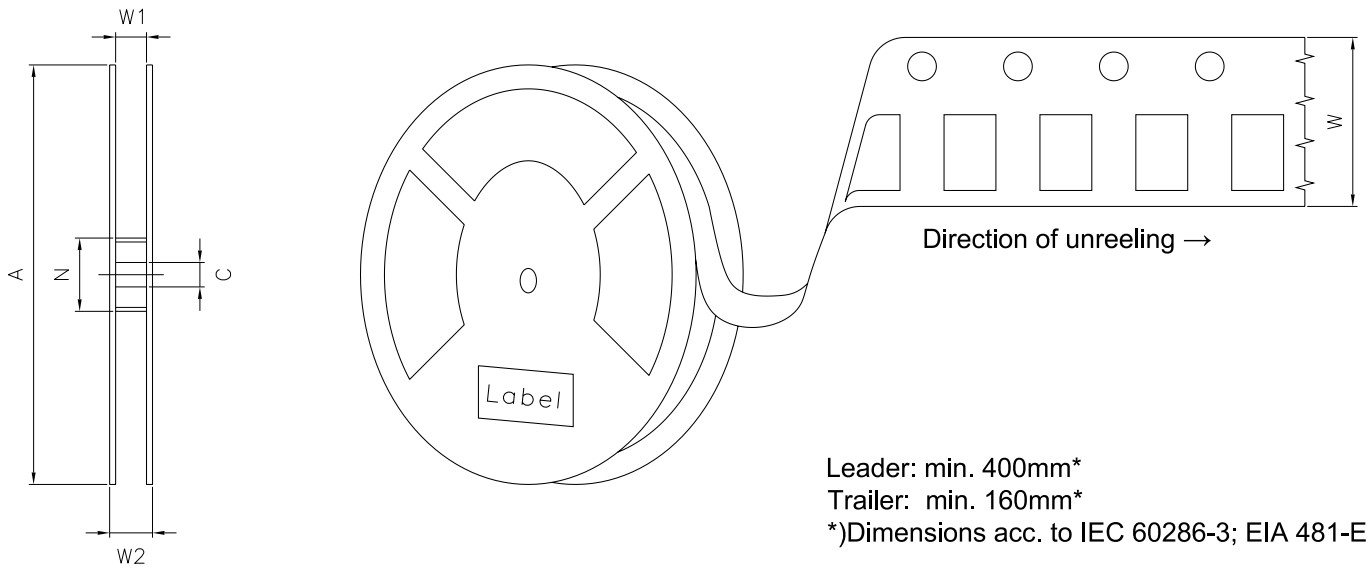
**Taping** <sup>8)</sup>



C63062-A4138-B7-03

Not for new design

**Tape and Reel** <sup>9)</sup>



**Reel Dimensions**

A	W	$N_{min}$	$W_1$	$W_{2max}$	Pieces per PU
180 mm	$8 + 0.3 / - 0.1$ mm	60 mm	$8.4 + 2$ mm	14.4 mm	4000

Not for new design



### Barcode-Product-Label (BPL)

**OSRAM Opto Semiconductors** LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890 ML Temp ST  
X XXX °C X

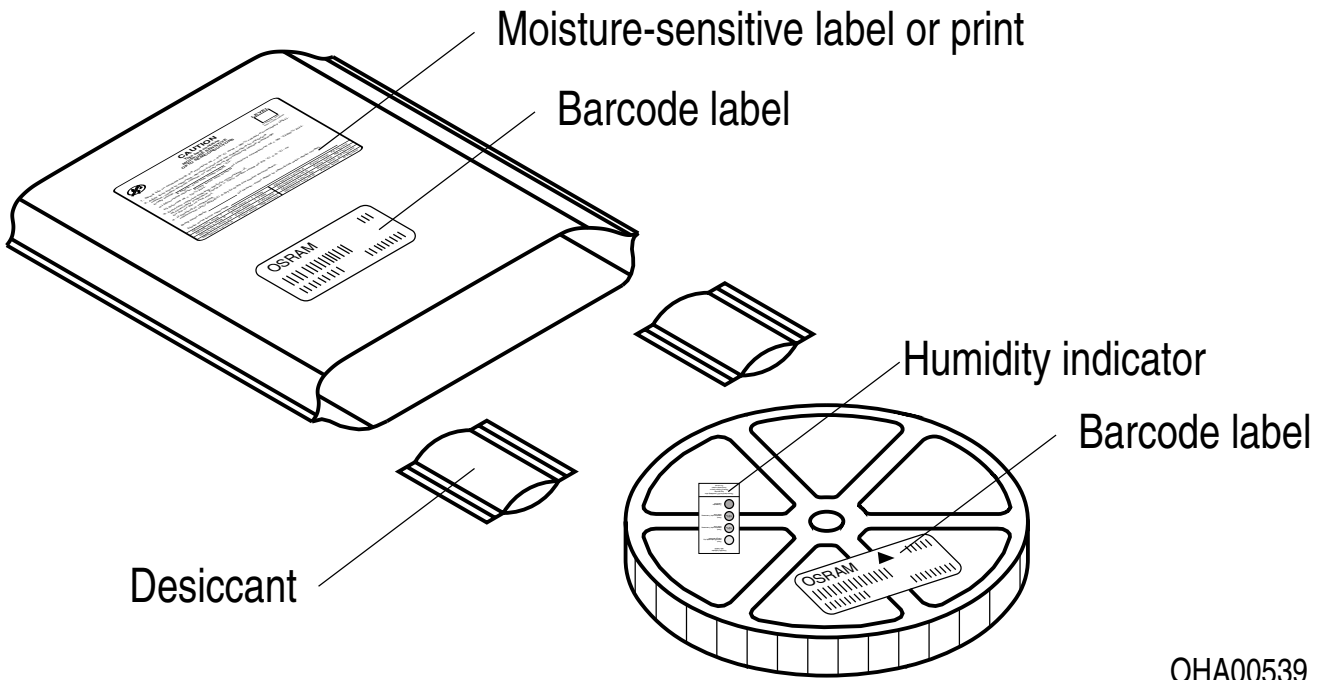
(1T) LOT NO: 1234567890 (9D) D/C: 1234 Pack: RXX  
DEMY XXX  
X\_X123\_1234.1234 X

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and name, a part number (LX XXXX), and a bin number (BIN1: XX-XX-X-XXX-X). It features three main barcode sections: a top one for batch number (6P), a middle one for lot number (1T), and a bottom one for product number (X). Text fields include RoHS Compliant, ML Temp ST (X XXX °C X), (9D) D/C: 1234, Pack: RXX, DEMY XXX, X\_X123\_1234.1234 X, and (Q)QTY: 9999. A QR code is located on the right side. A 'no liquid' symbol is also present.

OHA04563

### Dry Packing Process and Materials <sup>8)</sup>

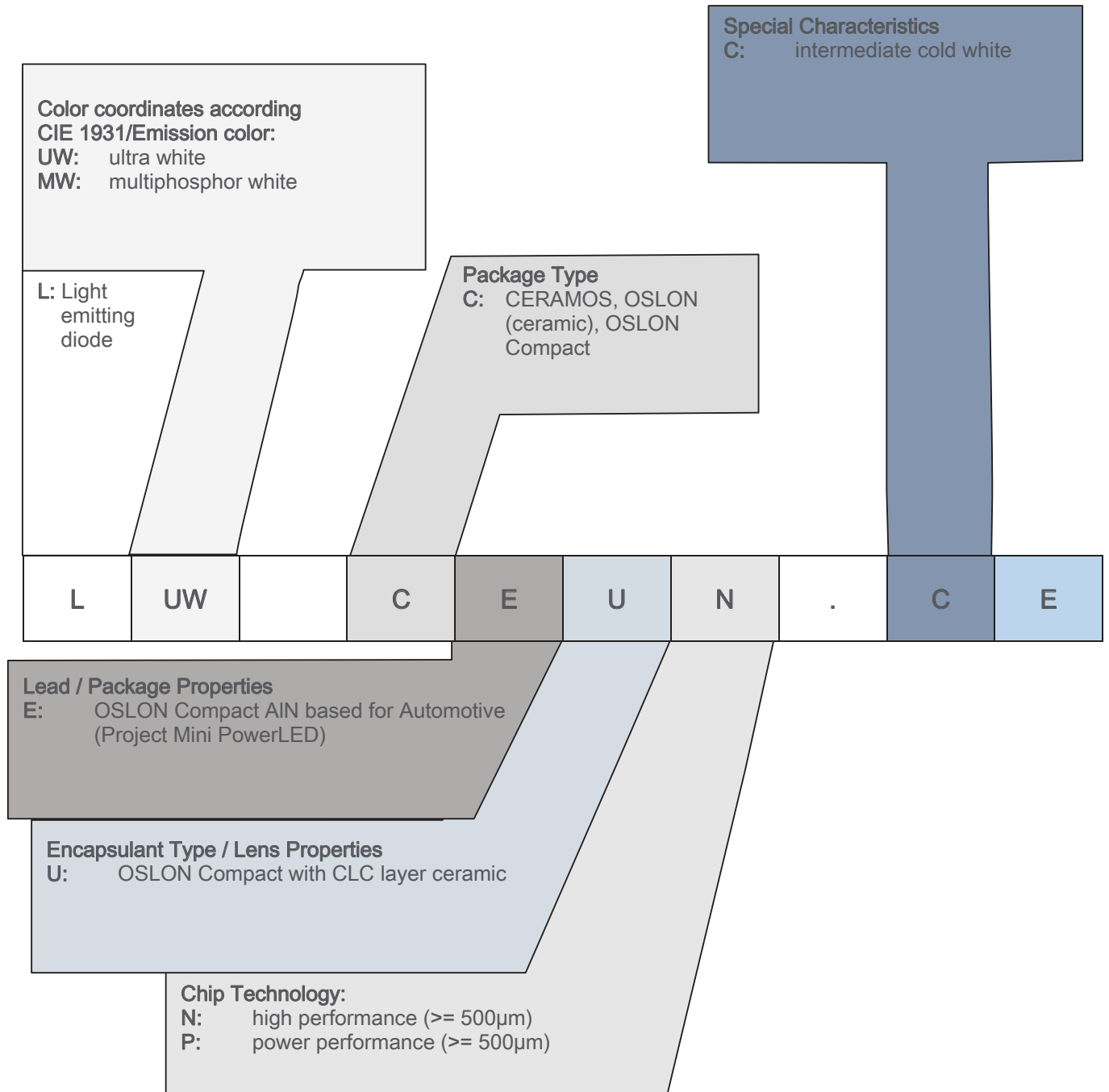


OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Not for new design

## Type Designation System



Not for new design

## Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers avoid device exposure to aggressive substances during storage, production, and use.

For further application related information please visit [www.osram-os.com/appnotes](http://www.osram-os.com/appnotes)

## Disclaimer

### **Attention please!**

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### **Product and functional safety devices/applications or medical devices/applications**

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

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## Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 0.005$  and an expanded uncertainty of  $\pm 0.01$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05$  V and an expanded uncertainty of  $\pm 0.1$  V (acc. to GUM with a coverage factor of  $k = 3$ ).
- 5) **Thermal Resistance:**  $R_{th\ max}$  is based on statistic values ( $6\sigma$ ).
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

## Revision History

Version	Date	Change
1.5	2020-04-27	Features Further Information Reel Dimensions Schematic Transportation Box Dimensions of Transportation Box Notes Disclaimer
1.6	2021-02-16	Not for new design Glossary

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